

# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
Name	Execution Date
Toshiyuki Takanohashi	10/08/2010
<b>RECEIVING PARTY DATA</b>	
Name:	Surpass Industry Co., Ltd.
Street Address:	2203, Shimooshi, Gyoda-shi
City:	Saitama
State/Country:	JAPAN
Postal Code:	361-0037
<b>PROPERTY NUMBERS Total: 1</b>	
Property Type	Number
Application Number:	12911867
<b>CORRESPONDENCE DATA</b>	
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ATTORNEY DOCKET NUMBER:	44445-05
NAME OF SUBMITTER:	Robert P. Michal
Total Attachments: 3 source=44445-05-Assignment#page1.tif source=44445-05-Assignment#page2.tif source=44445-05-Assignment#page3.tif	

OP \$40.00 12911867

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**PATENT**  
**REEL: 025193 FRAME: 0983**

**RECORDATION FORM COVER SHEET  
PATENTS ONLY**

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of conveying party(ies)**

Toshiyuki TAKANOHASHI

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

**3. Nature of conveyance/Execution Date(s):**

Execution Date(s) October 8, 2010

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Joint Research Agreement  
☐ Government Interest Assignment  
☐ Executive Order 9424, Confirmatory License  
☐ Other \_\_\_\_\_

**2. Name and address of receiving party(ies)**

Name: Surpass Industry Co., Ltd.

Internal Address: \_\_\_\_\_

Street Address: 2203, Shimooshi, Gyoda-shi

City: Saitama

State: \_\_\_\_\_

Country: JAPAN Zip: 361-0037

Additional name(s) & address(es) attached? ☐ Yes ☒ No

**4. Application or patent number(s):**

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☐ No

**5. Name and address to whom correspondence concerning document should be mailed:**

Name: Robert P. Michal

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State: New York Zip: 10016

Phone Number: 212-661-8000

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Email Address: \_\_\_\_\_

**6. Total number of applications and patents involved:** \_\_\_\_\_

**7. Total fee (37 CFR 1.21(h) & 3.41)** \$40.00

- ☐ Authorized to be charged to deposit account  
☒ Enclosed  
☐ None required (government interest not affecting title)

**8. Payment Information**

Deposit Account Number \_\_\_\_\_

Authorized User Name \_\_\_\_\_

**9. Signature:**

  
Signature

October 26, 2010

Date

Robert P. Michal

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

<b>ASSIGNMENT OF RIGHTS, TITLE AND INTEREST IN INVENTION</b>
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*This is an assignment of the following rights, title and interest (check all that apply):*

☒ *United States of America rights, title and interest in the invention*

☒ *Foreign rights, title and interest in the invention*

☐ *United States Patent Application Serial No.* \_\_\_\_\_

*Date of Execution:* \_\_\_\_\_ *Date of Filing:* \_\_\_\_\_

☐ *United States Provisional Patent Application Serial No.* \_\_\_\_\_

☐ *United States Patent No(s).* \_\_\_\_\_

☐ *International (PCT) Patent Application Serial No.* \_\_\_\_\_

☐ *Other (specify)* \_\_\_\_\_

***Title of the Invention:***

SOCKET STRUCTURE
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***Inventor (assignor):***

<i>Name</i>	<i>Address</i>
Toshiyuki TAKANOHASHI	C/O Surpass Industry Co., Ltd. 2203, Shimooshi, Gyoda-shi, Saitama 361-0037, JAPAN

***Assignee:***

<i>Name</i>	<i>Address</i>
Surpass Industry Co., Ltd.	2203, Shimooshi, Gyoda-shi, Saitama 361-0037 JAPAN

Whereas, I, the above-identified Inventor, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and /or patent(s) (hereinafter referred to as "Invention");

And, whereas I desire to assign my above-identified rights, title and interest in the Invention to the above-identified Assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

I hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said Invention, and in and to any and all reissues and reexaminations thereof, which may be granted or have granted for said Invention, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And I further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuation-in-part of said application for patent and/or for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

The undersigned hereby grant(s) the firm of LUCAS & MERCANTI, L.L.P., 475 Park Avenue South, New York, New York, 10016, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

***Inventor Signature:***

Name	Signature/ Date
Toshiyuki TAKANOHASHI	<i>Toshiyuki Takanohashi</i> OCT. 8, 2010